

PC401

Compact, Surface Mount Type OPIC Photocoupler

■ Features

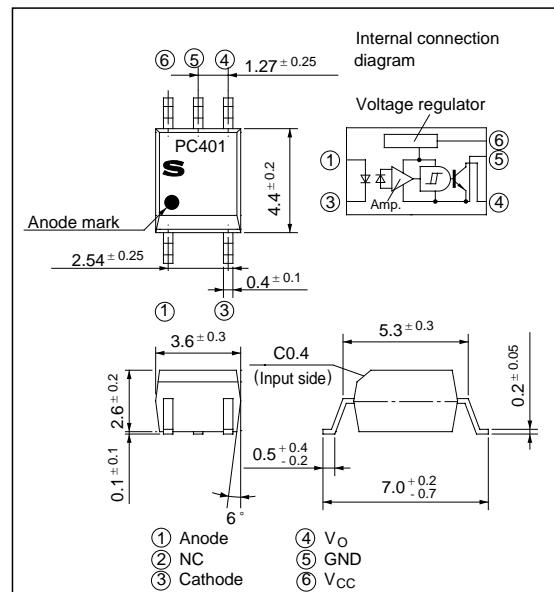
1. Mini-flat package
2. "High" output during light emission
3. Isolation voltage between input and output
(V_{iso} : 3 750V_{rms})
4. TTL and LSTTL compatible output
5. Recognized by UL(No.64380)

■ Applications

1. Hybrid substrate which requires high density mounting
2. Personal computers, office computers and peripheral equipment
3. Electronic musical instruments

■ Outline Dimensions

(Unit : mm)



* "OPIC" (Optical IC) is a trademark of the SHARP Corporation.
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Package Specifications

Model No.	Package specifications	Diameter of reel	Tape width
PC401	Taping package (Net : 3 000pcs.)	370mm	12mm
PC401T	Taping package (Net : 750pcs.)	178mm	12mm
PC401Z	Sleeve package (Net : 100pcs.)	-	-

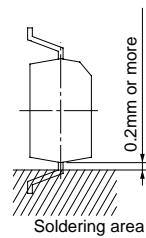
■ Absolute Maximum Ratings

(Ta = 25°C)

Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	mA
	Reverse voltage	V _R	V
	Power dissipation	P	mW
Output	Supply voltage	V _{CC}	V
	High level output voltage	V _{OH}	V
	Low level output current	I _{OL}	mA
	Power dissipation	P _O	mW
Total power dissipation	P _{tot}	150	mW
* ¹ Isolation voltage	V _{iso}	3 750	V _{rms}
Operating temperature	T _{opr}	- 25 to + 85	°C
Storage temperature	T _{stg}	- 40 to + 125	°C
* ² Soldering temperature	T _{sol}	260	°C

*1 AC for 1 minute, 40 to 60% RH

*2 For 10 seconds



■ Electro-optical Characteristics

(Ta = 0 to + 70°C unless otherwise specified.)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V _F	I _F = 4mA	-	1.1	1.4	V
			I _F = 0.3mA	0.7	1.0	-	
	Reverse current	I _R	Ta = 25°C, V _R = 3V	-	-	10	μA
	Terminal capacitance	C _t	Ta = 25°C, V = 0, f = 1kHz	-	30	250	pF
Output	Operating supply voltage	V _{CC}		3	-	15	V
	Low level output voltage	V _{OL}	I _F = 0, V _{CC} = 5V, I _{OL} = 16mA	-	0.2	0.4	V
	High level output current	I _{OH}	I _F = 4mA, V _{CC} = V _O = 15V	-	-	100	μA
	Low level supply current	I _{CCL}	I _F = 0, V _{CC} = 5V	-	2.5	5.0	mA
	High level supply current	I _{CCH}	I _F = 4mA, V _{CC} = 5V	-	2.7	5.5	mA
Transfer characteristics	* ³ "H→L" threshold input current	I _{FHL}	Ta = 25°C, V _{CC} = 5V, R _L = 280Ω	0.4	0.8	-	mA
			V _{CC} = 5V, R _L = 280Ω	0.3	-	-	
	* ⁴ "L→H" threshold input current	I _{FLH}	Ta = 25°C, V _{CC} = 5V, R _L = 280Ω	-	1.1	2.0	mA
			V _{CC} = 5V, R _L = 280Ω	-	-	4.0	
	* ⁵ Hysteresis	I _{FHL} / I _{FLH}	V _{CC} = 5V, R _L = 280Ω	0.5	0.7	0.9	
Response time	Isolation resistance	R _{ISO}	Ta = 25°C, DC500V, 40 to 60% RH	5 x 10 ¹⁰	10 ¹¹	-	Ω
	"H→L" propagation delay time	t _{PHL}	Ta = 25°C, V _{CC} = 5V R _L = 280Ω, I _F = 4mA	-	2	6	μs
	"L→H" propagation delay time	t _{PLH}		-	1	3	
	Fall time	t _f		-	0.05	0.5	
	Rise time	t _r		-	0.1	0.5	

*3 I_{FHL} represents forward current when output goes from high to low.

*4 I_{FLH} represents forward current when output goes from low to high.

*5 Hysteresis stands for I_{FHL} / I_{FLH}.

*6 Test circuit for response time is shown below.

Test Circuit for Response Time

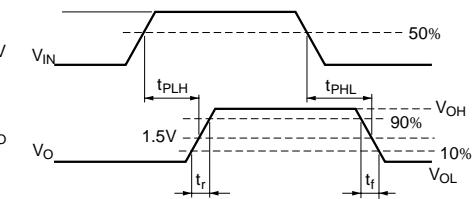
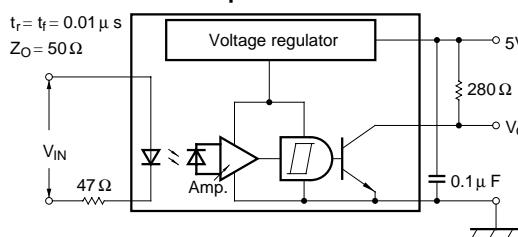


Fig. 1 Forward Current vs. Ambient Temperature

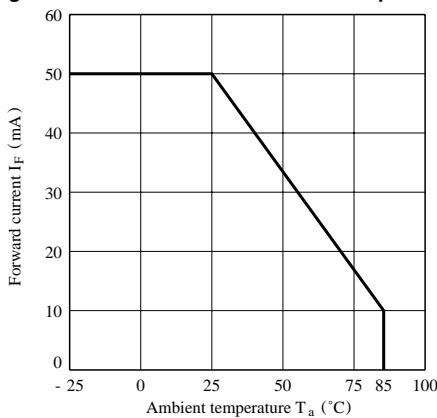
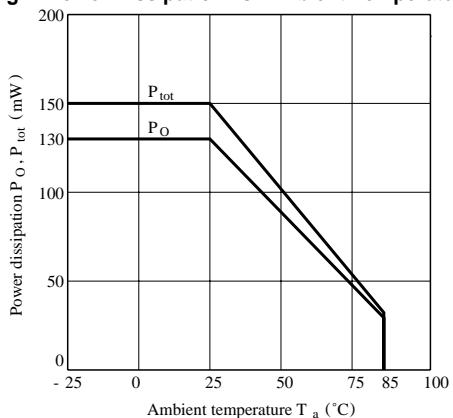
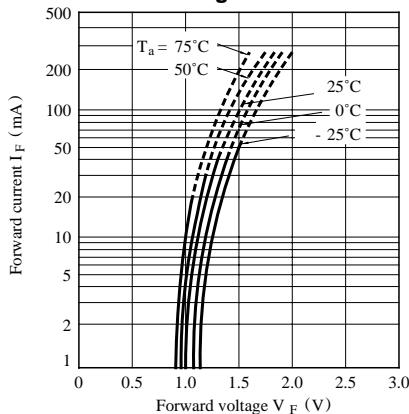


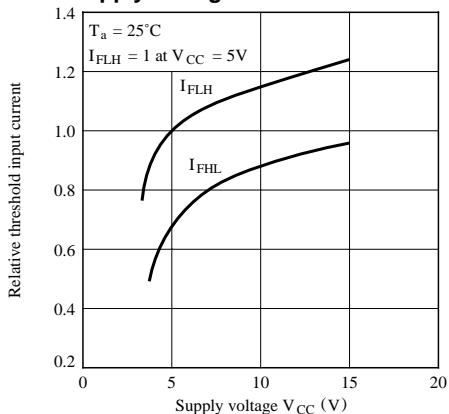
Fig. 2 Power Dissipation vs. Ambient Temperature



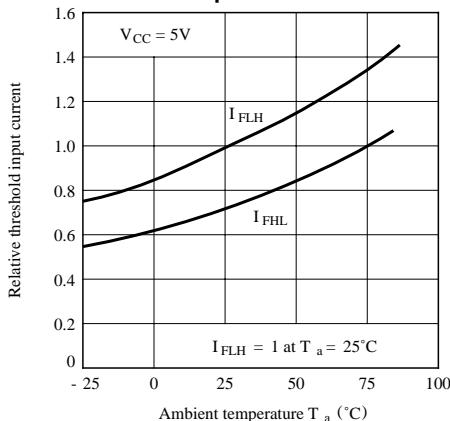
**Fig. 3 Forward Current vs.
Forward Voltage**



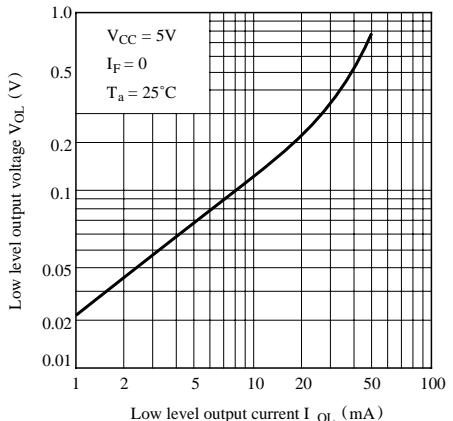
**Fig. 4 Relative Threshold Input Current vs.
Supply Voltage**



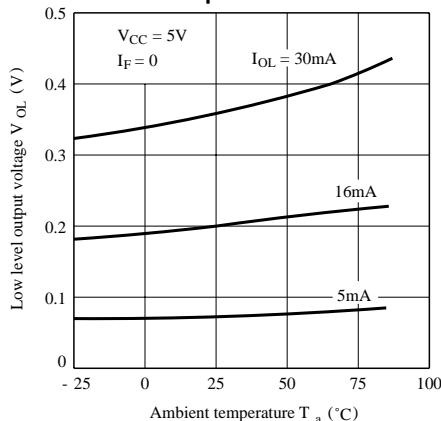
**Fig. 5 Relative Threshold Input Current vs.
Ambient Temperature**



**Fig. 6 Low Level Output Voltage vs.
Low Level Output Current**



**Fig. 7 Low Level Output Voltage vs.
Ambient Temperature**



**Fig. 8 High Level Output Current vs.
Forward Current**

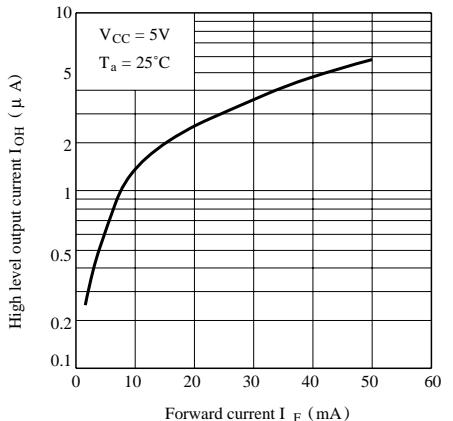


Fig. 9 High Level Output Current vs. Ambient Temperature

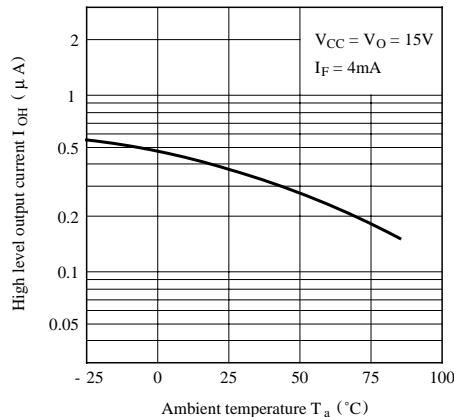


Fig.11 Propagation Delay Time vs. Forward Current

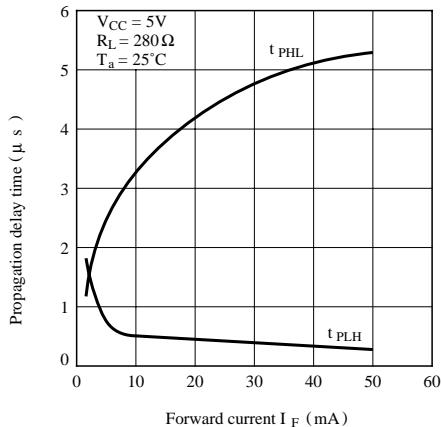


Fig.10 Supply Current vs. Supply Voltage

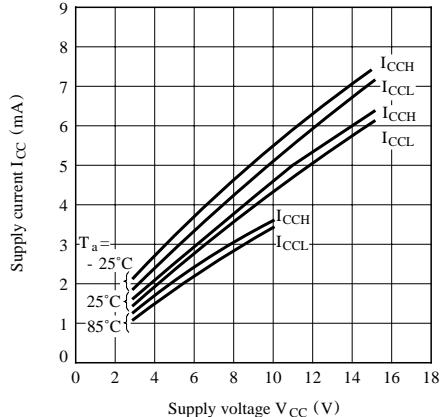
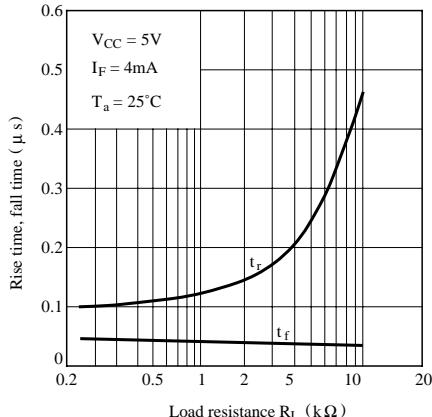


Fig.12 Rise Time, Fall Time vs. Load Resistance



■ Precautions for Use

- (1) It is recommended that a by-pass capacitor of more than $0.01\mu F$ is added between V_{cc} and GND near the device in order to stabilize power supply line.
- (2) Handle this product the same as with other integrated circuits against static electricity.
- (3) As for other general cautions, refer to the chapter "Precautions for Use"